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- Independent Registers for A and B Buses
- Multiplexed Real-Time and Stored Data
- Choice of True or inverting Data Paths
- Choice of 3-State or Open-Collector Outputs
- Package Options include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (NT) and Ceramic (JT) 300-mil DIPs

DEVICE	OUTPUT	LOGIC
SN54ALS646, SN74ALS646A, 'AS646	3 state	True
SN54ALS648, SN74ALS648A, SN74AS648	3 state	Inverting

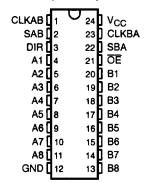
description

These devices consist of bus-transceiver circuits with 3-state or open-collector outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the octal bus transceivers and registers.

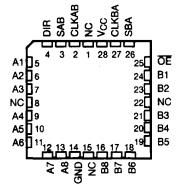
Output-enable (OE) and direction-control (DIR) inputs control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either or both registers.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode)

SN54ALS646, SN54ALS648, SN54AS646 . . . JT PACKAGE SN74ALS646A, SN74AS648, SN74AS648, SN74AS648 . . . DW OR NT PACKAGE (TOP VIEW)



SN54ALS646, SN54ALS648, SN54AS646 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

data. The circuitry used for select control eliminates the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. DIR determines which bus receives data when \overline{OE} is low. In the isolation mode (\overline{OE} high), A data may be stored in one register and/or B data may be stored in the other register.

When an output function is disabled, the input function is still enabled and can be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time.

The -1 version of the SN74ALS646A is identical to the standard version, except that the recommended maximum I_{OL} in the -1 version is increased to 48 mA. There are no -1 versions of the SN54ALS646, SN54ALS648A.

The SN54ALS646, SN54ALS648, and SN54AS646 are characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS646A, SN74ALS648A, SN74AS646, and SN74AS648 are characterized for operation from 0°C to 70°C.

TEXAS INSTRUMENTS SDAS039F - DECEMBER 1983 - REVISED JANUARY 1995

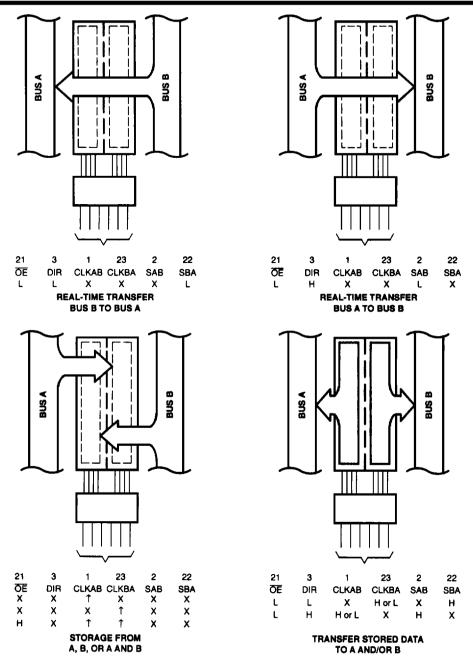


Figure 1. Bus-Management Functions

Pin numbers shown are for the DW, JT, and NT packages.



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Function Tables

SN54ALS646, SN54AS646, SN74ALS646A, SN74AS646

		INP	UTS			DAT	A 1/O	OCEDATION OF FUNCTION
ŌĒ	DIR	CLKAB	CLKBA	SAB	SBA	A1-A8	B1-B8	OPERATION OR FUNCTION
Х	X	1	Х	х	х	Input	Unspecified†	Store A, B unspecified [†]
X	x	X	1	x	x	Unspecified†	Input	Store B, A unspecified†
Н	Х	1	1	Х	Х	Input	Input	Store A and B data
Н	X	H or L	H or L	X	x	Input disabled	Input disabled	isolation, hold storage
L	L	Х	X	Х	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	н	Output	Input	Stored B data to A bus
L	н	X	Х	L	х	Input	Output	Real-time A data to B bus
L	Н	H or L	Х	Н	X	Input	Output	Stored A data to B bus

[†] The data output functions can be enabled or disabled by various signals at OE and DIR. Data input functions are always enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

SN54ALS648, SN74ALS648A, SN74AS648

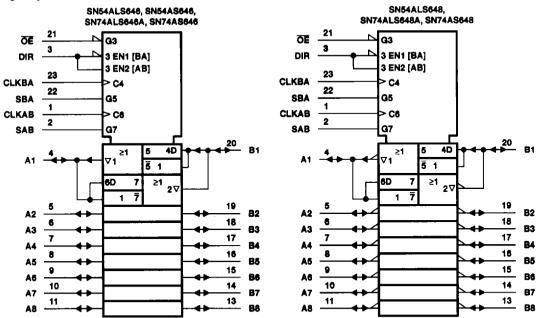
•		INP	UTS		•	DAT	A I/O	OPERATION OR FUNCTION
ŌĒ	DIR	CLKAB	CLKBA	SAB	SBA	A1-A8	B1-B8	OPERATION OR FUNCTION
х	х	Ť	Х	х	Х	Input	Unspecified [†]	Store A, B unspecified [†]
X ·	x	Х	1	х	х	Unspecified [†]	Input	Store B, A unspecified [†]
Н	х	1	1	Х	х	Input	Input	Store A and B data
Н	X	H or L	H or L	х	X	Input disabled	Input disabled	Isolation, hold storage
L	L	Х	Х	х	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	х	н	Output	Input	Stored \overline{B} data to A bus
L	Н	Х	×	L	×	Input	Output	Real-time A data to B bus
L	н	H or L	X	н	х	Input	Output	Stored A data to B bus

[†] The data output functions can be enabled or disabled by various signals at $\overline{\text{OE}}$ and DIR. Data input functions are always enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.



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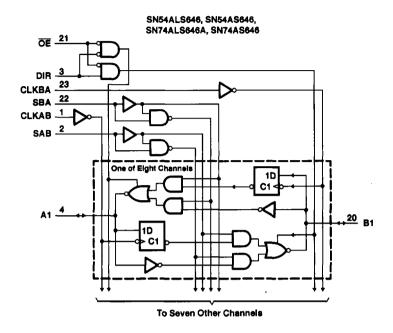
logic symbols†

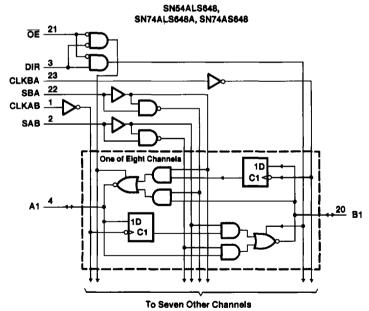


[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the DW, JT, and NT packages.



logic diagrams (positive logic)





Pin numbers shown are for the DW, JT, and NT packages.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

	•	•	• •	•
Supply voltage, V _{CC}				7 V
Input voltage, V _I : Control inputs				7 V
1/O ports				
Operating free-air temperature range, T _A :	SN54ALS646			-55°C to 125°C
	SN74ALS646A	٠		0°C to 70°C
Storage temperature range				-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN	SN54AL 3646		SN74ALS646A			UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	٧	
ViH	High-level input voltage	2			2			٧	
V_{IL}	Low-level input voltage			0.7			8.0	٧	
ЮН	High-level output current			-12			-15	mA	
1	Low-level output current			12			24		
lOL	Low-level output current						48‡	mA	
^f clock	Clock frequency	0		35	0		40	MHz	
t _w	Pulse duration, CLKBA or CLKAB high or low	14.5			12.5			ns	
t _{su}	Setup time, A before CLKAB↑ or B before CLKBA↑	15			10			ns	
th	Hold time, A after CLKAB↑ or B after CLKBA↑	0			0			ns	
TA	Operating free-air temperature	-55		125	0		70	•c	

[‡] Applies only to the -1 version and only if V_{CC} is maintained between 4.75 V and 5.25

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	7507.00	MIDITIONO	SN	54ALS6	46	SN7	4ALS64	6A	UNIT
	PARAMETER	lesi cc	ONDITIONS	MIN	TYPT	MAX	MIN	TYPT	MAX	UNII
ViK		V _{CC} = 4.5 V,	lj = -18 mA			-1.2			-1.2	٧
		V _{CC} = 4.5 V to 5.5 V,	I _{OH} ≈ -0.4 mA	V _{CC} -2			VCC-2			
٧			IOH = -3 mA	2.4	3.2		2.4	3.2		v
VOH		V _{CC} = 4.5 V	IOH = -12 mA	2						· •
			IOH = -15 mA				2			
			I _{OL} = 12 mA		0.25	0.4		0.25	0.4	
VOL		V _{CC} = 4.5 V	IOL = 24 mA		•			0.35	0.5	٧
			IOL = 48 mA‡					0.35	0.5	
1.	Control inputs	V _{CC} = 5.5 V	Vj = 7 V		,	0.1			0.1	4
\ 	A or B ports	7 VCC = 5.5 V	V _I = 5.5 V			0.1			0.1	mA
1	Control inputs	Ju 664	V 07V			20			20	
lН	A or B ports§	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μА
	Control inputs					-0.2			-0.2	
IIL	A or B ports§	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.2			-0.2	mA
lo¶	_	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
	-		Outputs high		47	76		47	76	
lcc		V _{CC} ≈ 5.5 V	Outputs low		55	88		55	88	mA
			Outputs disabled		55	88		55	88	

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[‡] Applies only to the -1 version and only if VCC is maintained between 4.75 V and 5.25

[§] For I/O ports, the parameters IIH and IIL include the off-state output current.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

PARAMETER	ARAMETER FROM (INPUT)	TO (OUTPUT)	CL R1 R2	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T _A = MIN to MAXT				
			SN54A	SN54ALS646		SN74ALS646A		
			MIN	MAX	MIN	MAX		
fmax			35		40		MHz	
[†] PLH	CLKBA or CLKAB	A or B	10	35	7	30		
[†] PHL	CLABA OF CLAAB	AUID	5	20	5	17	ns	
†PLH	A or B	D 4	5	22	3	20		
[†] PHL		B or A	3	15	3	12	ns	
^t PLH	SBA or SAB‡	A B	10	40	7	35		
^t PHL	(stored data low)	A or B	5	23	5	20	ns	
tPLH .	SBA or SAB‡	A or B	8	30	6	25		
t _{PHL}	(stored data high)	A or B	5	24	5	20	ns	
^t PZH	***	A or B	3	20	2	17		
[†] PZL	ŌĒ	A Of B	5	22	4	20	ns	
tPHZ	-	A or B	1	12	1	10		
^t PLZ	ŌĒ	A OF B	1	20	2	16	ns	
^t PZH	OID	A au D	5	38	3	30		
^t PZL	DIR	A or B	5	30	4	25	ns	
tPHZ	315	4 6	1	12	1	10		
tPLZ	DIR	A or B	2	21	2	16	ns	

[†] For conditions shown MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

absolute maximum ratings over operating free-air temperature range (unless other	erwise noted)†
Supply voltage, V _{CC}	7 V
Input voltage, V _I : Control inputs	
I/O ports	5.5 V
Operating free-air temperature range, T _A : SN54ALS648	-55°C to 125°C
SN74ALS648A	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54ALS648		SN74ALS648A			UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNII	
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V	
VIH	High-level input voltage	2			2			٧	
VIL	Low-level input voltage			0.7			0.8	٧	
Юн	High-level output current			-12			-15	mÄ	
OL	Low-level output current			12			24	mA	
fclock	Clock frequency	0		35	0		40	MHz	
t _w	Pulse duration, CLKBA or CLKAB high or low	14.5			12.5			ns	
t _{su}	Setup time, A before CLKABT or B before CLKBAT	15			10			ns	
th	Hold time, A after CLKAB↑ or B after CLKBA↑	0			0			ns	
TA	Operating free-air temperature	-55		125	0		70	°C	

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		7505.00	N. D. ST. O. L. O.	SN	54ALS6	48	SN7	4ALS64	BA ABI	116117
PARAMETER		TEST CC	ONDITIONS	MIN	TYP	MAX	MIN TYPT		MAX	UNIT
ViK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2			-1.2	٧
		V _{CC} = 4.5 V to 5.5 V,	I _{OH} = -0.4 mA	V _{CC} -2			V _{CC} -2			
V			I _{OH} = -3 mA	2.4	3.2		2.4	3.2		v
VOH		V _{CC} = 4.5 V	I _{OH} = -12 mA	2						٧
			I _{OH} = -15 mA				2			
V	V _{CC} = 4.5 V		I _{OL} = 12 mA		0.25	0.4		0.25	0.4	V
VOL		VCC = 4.5 V	I _{OL} = 24 mA					0.35	0.5	
1.	Control inputs VCC = 5.5 V		V _I = 7 V			0.1			0.1	mA
4	A or B ports	VCC = 5.5 V	V _I = 5.5 V			0.1			0.1	IIIA
la.	Control inputs	V 55V	V. 07V			20			20	4
lΗ	A or B ports‡	V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μA
	Control inputs	.,				-0.2			-0.2	
ΙL	A or B ports‡	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.2			-0.2	mA
ΙΟ§	_	V _{CC} = 5.5 V,	V _O = 2.25 V	-20		-112	-30		-112	mA
			Outputs high		47	76		47	76	,
lcc		V _{CC} = 5.5 V	Outputs low		57	88		57	88	mA
			Outputs disabled		57	88		57	88	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

^{\$} The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L R1 R2	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T_A = MIN to MAXT				
			SN54A	SN54ALS648		SN74ALS648A		
			MIN	MAX	MIN	MAX		
fmax			35		40		MHz	
tPLH .	CLKBA or CLKAB	A or B	8	39	7	33	ns	
tPHL .	CERBA OF CERAB	AOID	5	23	5	20	ns	
tPLH	A or B	B or A	3	20	2	17	ns	
tPHL	1 4018	BUIX	2	12	2	10	l ns	
tPLH	SBA or SAB‡	A or B	5	44	5	39	ns	
tPHL temperature	(stored data low))	4	26	4	22	118	
t _{PLH}	SBA or SAB‡	A ov D	6	30	6	25		
tPHL t	(stored data high)	A or B	6	25	6	21	ns	
t _{PZH}	A==	A D	4	25	2	22		
tPZL	→ ŌĒ	A or B	4	25	4	22	ns	
t _{PHZ}		A av D	1	12	1	10		
^t PLZ	ŌĒ	A or B	2	21	2	15	ns	
tPZH	DIR	A or B	4	35	2	27		
^t PZL] Din	AOIB	3	25	3	19	ns	
t _{PHZ}	DID	A B	1	17	1	14		
t _{PLZ}	DIR	A or B	2	22	2	15	ns	

For conditions shown MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	
Input voltage, Vi: Control inputs	
1/O ports	5.5 V
Operating free-air temperature range, T _A : SN54AS646	
SN74AS646	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SI	N54AS64	16	SN74AS646		UNIT	
ĺ			MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage		4.5	5	5.5	4.5	5	5.5	٧
ViH	High-level input voltage		2			2			٧
VIL	Low-level input voltage				8.0			8.0	٧
ЮН	High-level output current				-12		_	-15	mA
lOL	Low-level output current			_	32			48	mA
fclock*	Clock frequency		0		75	0	-	90	MHz
	Pulse duration	CLKBA or CLKAB high	6			5			
tw*	Puise duration	CLKBA or CLKAB low	7			6			ns
t _{su} *	Setup time, A before CLKAB↑ or B before	CLKBAT	7			6			ns
th*	Hold time, A after CLKAB↑ or B before CL	KBA	0			0			ns
TA	Operating free-air temperature		-55	•	125	0		70	°C

On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED		7507.00	NOTIONS	SN54AS646		SN74AS646			LIAUT	
	PARAMETER	TEST CONDITIONS		MIN	TYPT	MAX	MIN	TYPT	MAX	UNIT
Vik		V _{CC} = 4.5 V,	lj = -18 mA			-1.2			-1.2	٧
		V _{CC} = 4.5 V to 5.5 V,	I _{OH} = -2 mA	V _{CC} -2			V _{CC} -2			
٧		V _{CC} = 4.5 V	I _{OH} = -3 mA	2.4	3.2		2.4	3.2		v
VOH			I _{OH} = -12 mA	2						
			I _{OH} = -15 mA				2	2		
VOL		V _{CC} = 4.5 V	I _{OL} = 32 mA		0.25	0.5				v
VOL		VCC = 4.5 V	I _{OL} = 48 mA					0.35	0.5	
 հյ	Control inputs	V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1 0.1	mΑ
4	A or B ports	VCC = 5.5 V,	V _I = 5.5 V			0.1				ША
1	Control inputs	T.,	V _I = 2.7 V			20			20	μА
ΉΗ	A or B ports‡	V _{CC} = 5.5 V,				70			70	μΑ
l	Control input	V EEV				-0.5			-0.5	mA
ηL	A or B ports‡	V _{CC} = 5.5 V,	V _i = 0.4 V			-0.75			-0.75	IIIA
IO§		V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	-30		-112	mA
			Outputs high		120	195		120	195	
ICC		V _{CC} = 5.5 V	Outputs low		130	211		130	211	mA
			Outputs disabled		130	211		130	211	

[†] All typical values are at V_{CC} = 5 V, T_A = 25 °C.

For I/O ports, the parameters IIH and IIL include the off-state output current.

^{\$} The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

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PARAMETER	TER FROM (INPUT)	TO (OUTPUT)	C _L R1 R2	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T _A = MIN to MAX [†]			
	1		SN54/	SN54A8646		SN74AS646	
	l		MIN	MIN MAX MIN	MIN	MAX	
fmax*			75		90		MHz
tPLH	CLKBA or CLKAB	A or B	2	9.5	2	8.5	ns
tpHL _	CERBA GI CERAB		2	10	2	9	= =
†PLH	A or B	B or A	2	11.5	2	9	ns
tpHL	A OF B	BOTA	1	8	1	7	113
[†] PLH	994 948 [‡]	A or B	2	13.5	2	11	ns
tpHL	SBA or SAB‡		2	11	2	9	ns
^t PZH	ŌĒ	A or B	2	11	2	9	ns
†PZL	OE I	AUID	3	15	3	14	118
tpHZ	ŌĒ	A or B	2	11	2	9	ns
tPLZ] OE	A OF B	2	11	2	9	113
tpzH	DIR	A or B	3	21	3	16	ns
†PZL			3	24	3	18	1 118
^t PHZ	DIR	A av D	2	12	2	10	
tpLZ	DIR	A or B	2	12	2	10	ns

On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

[†] For conditions shown MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

 Supply voltage, V_{CC}
 7 V

 Input voltage, V_I: Control inputs
 7 V

 I/O ports
 5.5 V

 Operating free-air temperature range, T_A: SN74AS648
 0°C to 70°C

recommended operating conditions

			SN74AS		18	UNIT
			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	٧
VIH	High-level input voltage		2			٧
VIL	Low-level input voltage				0.8	٧
Іон	High-level output current				-15	mA
10L	Low-level output current				48	mA
fclock	Clock frequency		0		90	MHz
	Pulse duration	CLKBA or CLKAB high	5			
¹w	Pulse duration	CLKBA or CLKAB low	6			ns
t _{su}	Setup time, A before CLKAB↑ or B before CLKBA↑		6			ns
t _h	Hold time, A after CLKAB↑ or B before CLKBA		0			ns
TA	Operating free-air temperature		0		70	•C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

•	PARAMETER	TEST COME	NITIONIC	SN74AS648		UNIT	
	PANAMEIER	TEST COND	JITIONS	MIN TYP [‡] MAX -1.2 V _{CC} -2 2.4 3.2 2 0.35 0.5 0.1 0.1 20 70 -0.5 -0.75 -30 -112	CALL		
٧ _{IK}		V _{CC} = 4.5 V,	l _l = -18 mA			-1.2	٧
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	I _{OH} = -2 mA	V _{CC} -2			
۷он		V 45V	I _{OH} = -3 mA	2.4	3.2		v
		V _{CC} = 4.5 V	IOH = -15 mA	5 mA 2			
VOL		V _{CC} = 4.5 V,	I _{OL} = 48 mA		0.35	0.5	٧
l _l	Control inputs	V _{CC} = 5.5 V	V _I = 7 V			0.1	
	A or B ports		V _I = 5.5 V			0.1	mA
	Control inputs					20	
lН	A or B ports§	V _{CC} = 5.5 V,	V _I = 2.7 V			70	μА
	Control input				_	-0.5	
liL.	A or B ports§	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.75	mA
lo [¶]		V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	mΑ
			Outputs high		110	185	
lcc		$V_{CC} = 5.5 V$	Outputs low		120	195	mA
			Outputs disabled		120	195	

[‡] All typical values are at V_{CC} = 5 V, T_A = 25 °C.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

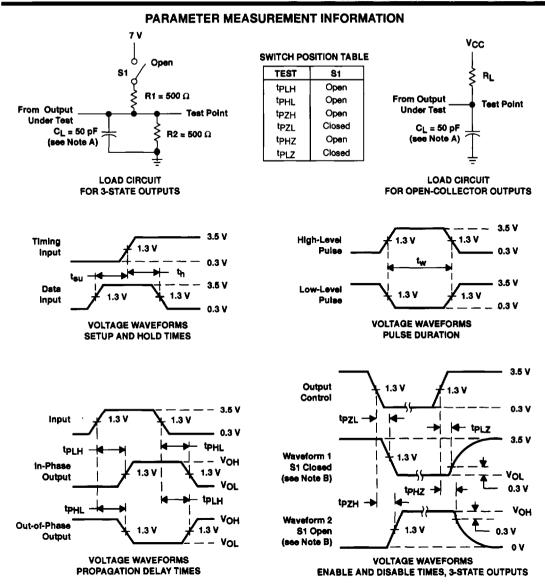
[§] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 C _L = 50 pF R1 = 500 Ω R2 = 500 Ω T _A = MIN t	UNIT	
			SN74	SN74A\$648	
	j		MIN	MAX	
f _{max}			90		MHz
tPLH .	CLKBA or CLKAB	A or B	2	8.5	ns
†PHL	CERBA OF CERAB	A 01 B	2	9	
†PLH	A or B	B or A	2	8	
^t PHL] Aorb	BOTA	1	7	ns
t _{PLH}	ODA OART	A or B	2	11	
^t PHL	SBA or SAB‡	AOIB	2	9	ns
tPZH	ŌĒ	A or B	2	9	ns
tPZL) OE	AOTE	3	15	1115
†PHZ	ŌĒ	A or B	2	9	ns
†PLZ] OE		2	9	
†PZH	DIR	A or B	3	16	
^t PZL	Din	AUID	3	18	ns
^t PHZ	DIR	A or B	2	10	
tPLZ		Aorb	2	10	ns

[†] For conditions shown MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

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NOTES: A. Ci includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \, \Omega$, $t_f \leq 2$ ns. $t_f \leq 2$ ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuits and Voltage Waveforms

